

	Type	Hit s	Search Text	DBs	Time Stamp	Error Co mm enfi ts ni ti on	Error De ro rs	Ref #
1	IS&R	2	("6642158").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/30 12:22			S1
2	IS&R	3	("5821627").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:25			S2
3	IS&R	2	("6486553").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:26			S3
4	IS&R	2	("4376154").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:26			S4
5	IS&R	2	("4983250").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:27			S5
6	IS&R	2	("5230965").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:27			S6
7	IS&R	2	("5264108").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:28			S7
8	IS&R	2	("4457950").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:28			S8
9	IS&R	2	("4925522").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:29			S9
10	BRS	3	"2003102262"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:33			S10
11	BRS	3	"2002063394"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:35			S11

12	BRS	3	"2000021546"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/27 22:37				S12
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			Search Text	DBs	Time Stamp	Cor ro de ni ti on	Er ro rs	Ref #
Type	Hit s							
13	BRS	1	2002-636602.NRAN.	DERWENT	2004/11/29 10:23			S13
14	BRS	45	(tin or sn) near (copper or cu) near alloy with substrate	DERWENT	2004/11/30 16:13			S14
15	BRS	1	(tin or sn) near (copper or cu) near alloy with substrate and (package or pcb or circuit adj board or die) and (tin or sn) with organic	DERWENT	2004/11/27 23:00			S16
16	BRS	8	(tin or sn) near (copper or cu) near alloy with substrate and (package or pcb or circuit adj board or die)	DERWENT	2004/11/27 22:54			S15
17	BRS	309	(tin or sn) with precursor	DERWENT	2004/11/30 16:14			S17
18	BRS	10	(tin or sn) with precursor and alloy and (cu or copper)	DERWENT	2004/11/27 23:02			S18
19	BRS	31	"102262"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/29 10:24			S19

20	BRS	3	"2003102262"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/29 10:26				S20
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	Type	Hit s	Search Text	DBs	Time Stamp	Co mm en ts	Er ro r De fin iti on	Er ro r De fin iti on	Ref #
21	BRS	1	2004-053486.NRAN.	DERWENT	2004/11/29 10:26				S21
22	BRS	3	"2003102262"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/29 10:26				S22
23	IS& R	3	("5821627").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	2004/11/30 14:59				S23
24	BRS	5	apparatus and (tin or sn) near (copper or cu) near alloy with substrate	DERWENT	2004/11/30 16:13				S24
25	BRS	1	apparatus and (tin or sn) with precursor and alloy	DERWENT	2004/11/30 16:16				S25
26	BRS	606	apparatus and (tin or sn) with alloy	DERWENT	2004/11/30 16:16				S26
27	BRS	275	apparatus and (tin or sn) with (cu or copper) with alloy	DERWENT	2004/11/30 16:16				S27
28	BRS	62	apparatus with (tin or sn) with (cu or copper) with alloy	DERWENT	2004/11/30 16:17				S28